PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Po Lin Yeh	09/10/2010
Chien-Hsing Lin	08/15/2010
Shao Ping Hung	08/23/2010
Chih-Tien Chang	09/01/2010
Chun-Chia Chen	07/15/2010
Jui Hua Yeh	07/15/2010

RECEIVING PARTY DATA

Name:	MStar Semiconductor, Inc.
Street Address:	4F-1, No. 26, Tai-Yuan St., Chupei
City:	Hsinchu Hsien
State/Country:	TAIWAN
Postal Code:	302

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12956071

CORRESPONDENCE DATA

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Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 301-424-3640 Email: kew@usiplaw.com Correspondent Name: Lawrence D. Eisen

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ATTORNEY DOCKET NUMBER: 0470.0128C

PATENT REEL: 025432 FRAME: 0505 501363607

NAME OF SUBMITTER:	Lawrence D. Eisen
Total Attachments: 2 source=ExecutedAssn#page1.tif source=ExecutedAssn#page2.tif	

PATENT REEL: 025432 FRAME: 0506

ASSIGNMENT

For good and valuable consideration, I/WE, Po Lin Yeh, Chien-Hsing Lin, SHAO PING HUNG, CHIH-TIEN CHANG, Chun-Chia Chen and JUI-HUA YEH hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to MStar Semiconductor, Inc., having its principal place of business at 4F-1, Number 26, Tai-Yuan St. Chupei, Hsinchu Hsien 302, Taiwan, R.O.C., hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on	as US. Application Serial No,	
entitled:	Phase Digitizing Apparatus and Mothod	Thereof
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and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

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Attorney Docket No. 0470.0128C Ref. No. MST0486-US

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:	Po Lin Yeh	DATE:	09/10/2010
SIGNATURE:	Chien Haing Lin Chien-Haing Lin	DATE:	08/15/2010
SIGNATURE:	SHAO PING HUNG	DATE:	08/23/2010
, SIGNATURE:	Chh-Tien Chang CHIH-TIEN CHANG	DATE:	09/01/200
SIGNATURE:	Chun-Chia Chen Chun-Chia Chen		or ox 21 /. No
SIGNATURE:	Jui Hua Yeh JUI-HUA YEH	DATE:	01/18/2000

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PATENT REEL: 025432 FRAME: 0508